Off-Line, High Voltage EL Lamp Driver

Features

- Processed with HVCMOS® technology
- ▶ Input voltage up to 200V DC
- ▶ 400V peak-to-peak output voltage
- Output load up to 350nF (100in² for 3.5nF/in² lamp)
- Adjustable output lamp frequency
- Adjustable on/off pulsing frequency

Applications

- ▶ Electronic organizers
- Handheld portable computers
- Display signs
- Portable instrumentation equipment

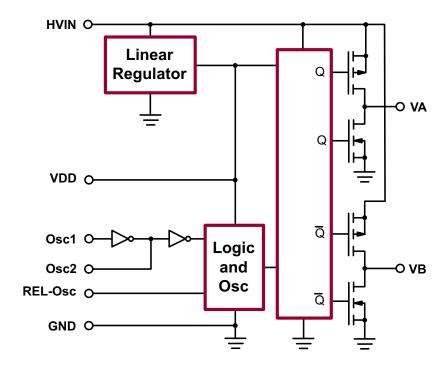
General Description

The Supertex HV809 is an off-line, high voltage, EL lamp driver integrated circuit designed for driving EL lamps of up to 350nF at 400Hz. The input supply voltage can be a rectified nominal 120V AC source or any other DC source up to 200V. The HV809 will supply the EL lamp with an AC square wave with a peak-to-peak voltage of two times the input DC voltage.

The HV809 has two internal oscillators, a low voltage output linear regulator, and a high voltage output H-bridge. The high voltage output H-bridge frequency is set by an external resistor connected between the REL-Osc and GND pins. The EL lamp is connected between pins VA and VB. For the HV809 in the 8-pin package, an external RC network can be connected between the oscillator's Osc1 and Osc2 pins to pulse the EL lamp on and off.

For detailed circuit and application information please refer to Application Note AN-H36.

Block Diagram



Ordering Information

Part Number	Package Option	Packing				
HV809K2-G	7-Lead TO-220	50/Tube				
HV809LG-G	8-Lead SOIC	2500/Reel				
HV809SG-G	8-Lead SOIC w/ heat slug	2500/Reel				

⁻G denotes a lead (Pb)-free / RoHS compliant package

Absolute Maximum Ratings

Parameter	Value
HV _{IN} , High voltage input	+210V
V _{DD} , Internal supply voltage	+15V
Operating temperature range	-25°C to +85°C
Storage temperature range	-55°C to +150°C
Power dissipation:	
8-Lead SOIC	500mW
8-Lead SOIC w/ Heat Slug	1.5 Watts
7-Lead TO-220*	15Watts

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

Product Marking



L = Lot Number
YY = Year Sealed
WW = Week Sealed
_____ = "Green" Packaging

Package may or may not include the following marks: Si or 🌎

7-Lead TO-220

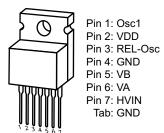


Y = Last Digit of Year Sealed WW = Week Sealed L = Lot Number _____ = "Green" Packaging

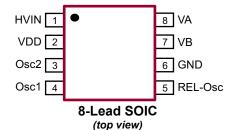
Package may or may not include the following marks: Si or 쮥

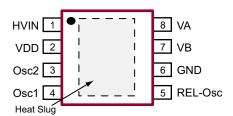
8-Lead SOIC

Pin Configuration



7-Lead TO-220 (front view)





8-Lead SOIC w/ Heat Slug (top view) (Heat slug is at ground potential)

Typical Thermal Resistance

Package		$oldsymbol{ heta_{ja}}$
7-Lead TO-220		29°C/W
8-Lead SOIC		101°C/W
8-Lead SOIC w/ heat	slug	84°C/W

Recommended Operating Conditions

Sym	Parameter	Min	Тур	Max	Units	Conditions
HV_{IN}	High voltage input	50	-	200	V	
	Load canacitance	-	-	350	nF	R _{EL} = 1.0MΩ, HV _{IN} = 170V
C_{L}	Load capacitance	-	-	150	nF	R _{EL} = 390kΩ, HV _{IN} = 170V
T _A	Operating temperature	-25	-	85	οС	

^{*} With external heat sink mounted, refer to App Note AN-H36.

Electrical Characteristics

DC Characteristics (Over recommended operating conditions unless otherwise specified - T_A = 25°C)

Sym	Parameter	Min	Тур	Max	Units	Conditions
	High voltage outply ourrent	-	-	70	mA	$HV_{IN} = 170V, R_{EL} = 1.0M\Omega, C_{L} = 350nF$
I _{IN}	High voltage supply current	-	-	9.0	mA	$HV_{IN} = 170V, R_{EL} = 1.0M\Omega, C_{L} = 50nF$
	Quiggeent gunnly gurrent	-	-	400	μA	HV_{IN} = 170V, R_{EL} = 1.0M Ω , Osc1 = GND, No Load
I _{INQ}	Quiescent supply current	-	-	100	μA	$HV_{IN} = 170V, R_{EL} = 1.0M\Omega,$ Osc1 = V_{DD} , No Load
ISINK	Osc2 sink current*	-	300	-	μA	V _{Osc2} = 1.0V
SOURCE	Osc2 source current*	-	100	-	μΑ	$V_{Osc2} = V_{DD} -1.0V$
l _{Osc1}	Osc1 logic input leakage current	-	±10	-	μA	V_{Osc1} = GND and V_{DD}
V _{Osc1(hyst)}	Osc1 hysteresis voltage	-	2.5	-	V	
V _{A-B}	Min differential output voltage across lamp	-	-	400	V	HV _{IN} = 200V
V _{DD}	Internal supply voltage	8.0	10	12	V	No load on V _{DD}
I _{DD (OUT)}	Output V _{DD} current	4.0	-	-	mA	For HV809K2, $\Delta V_{DD} = 1.0V$

^{*} ${\it I_{\rm SINK}}$ and ${\it I_{\rm SOURCE}}$ are not valid for the TO-220 package.

AC Characteristics (Over recommended operating conditions unless otherwise specified - T_A = 25°C)

Sym	Parameter	Min	Тур	Max	Units	Conditions
		320	400	480	⊔- ₇	$R_{EL} = 1.0M\Omega$,
f	V _{A-B} output drive frequency			400	112	Osc1 = GND, $C_L = 350nF$
f_{EL}		0.8	1.0	1.2	V∐→	$R_{EL} = 390k\Omega$,
		0.6		1.2	KI IZ	
t _r	Output rise time	-	180	250	μs	$C_{L} = 150 nF, HV_{IN} = 170 V$
t,	Output fall time	-	50	100	μs	C ₁ = 150nF, HV _{IN} = 170V

Function Table

Input	Out	puts
Osc1	VA	VB
GND	Enabled	Enabled
VDD	Disabled	Disabled

Figure 1. AC Off-Line EL Lamp

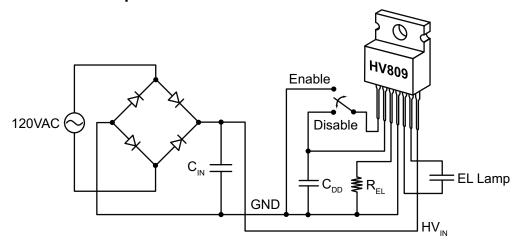


Figure 2. Pulsing EL Lamp

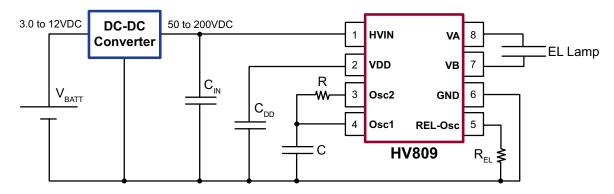
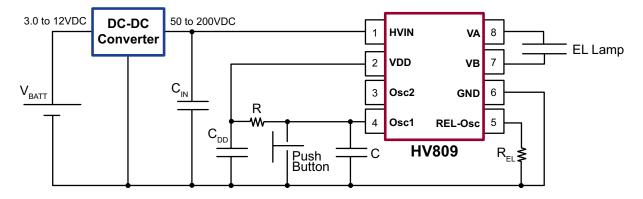
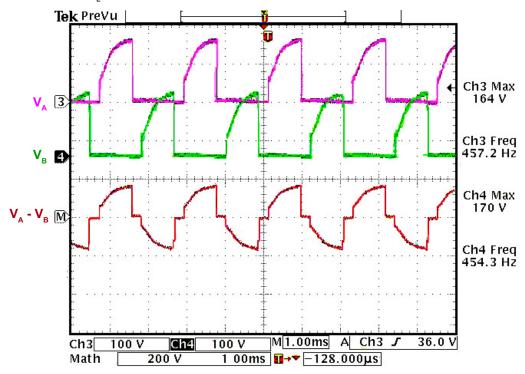


Figure 3. Push-Button, Delayed Turn Off



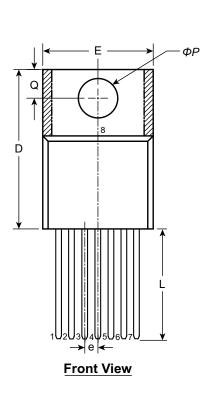
Typical Waveform on V_A , V_B , and Differential Waveform V_A - V_B (HV_{IN} = 170V, R_{EL} = 1.0M Ω , and C_L = 350nF)

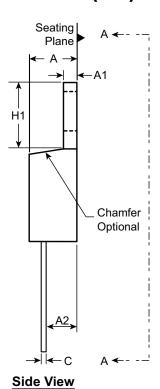


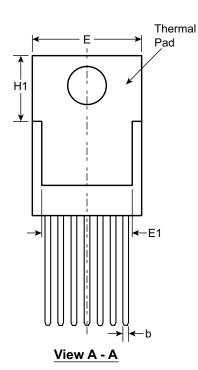
Function Table

Pin Name	Description
Osc1	The Output H-bridge can be enabled and disabled by connecting the Osc1 pin to the GND and VDD pins. The output can be left enabled by connecting the Osc1 pin to GND.
Osc2	The RC network can be connected between the oscillator's Osc1 and Osc2 pins to pulse the EL lamp on and off.
VDD	Internal supply voltage.
REL-Osc	EL lamp frequency is controlled via an external R_{EL} resistor connected between the REL-Osc and GND pins of the device.
VB	VB side of the EL lamp driver H-bridge. Connection for one of the EL lamp terminals.
VA	VA side of the EL lamp driver H-bridge. Connection for one of the EL lamp terminals.
HVIN	High voltage input supply pin.
GND	Ground pin.

7-Lead TO-220 Package Outline (K2)







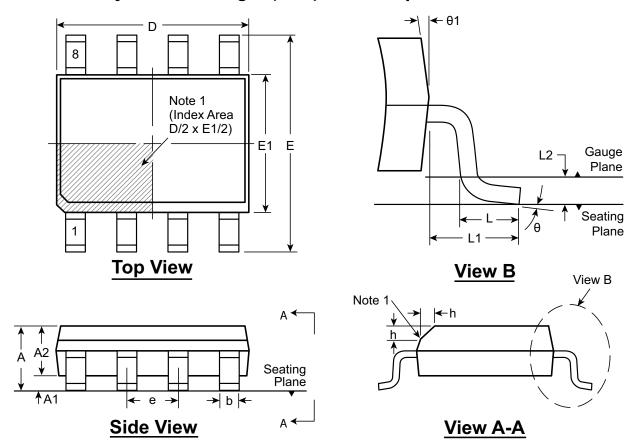
Symbo	l	Α	A1	A2	b	С	D	E	E1	е	H1	L	Q	ФΡ
	MIN	.160	.045	.090	.023	.015	.560	.385		.045	.234	.540	.103	.146
Dimension (inches)	NOM	-	-	-	-	-	-	-	.300 REF	-	-	-	-	-
	MAX	.190	.055	.115	.037	.022	.590	.415		.055	.258	.560	.113	.156

Drawings not to scale.

Supertex Doc. #: DSPD-7TO220K2, Version NR090308.

8-Lead SOIC (Narrow Body) Package Outline (LG)

4.90x3.90mm body, 1.75mm height (max), 1.27mm pitch



Note:

This chamfer feature is optional. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbo	ı	Α	A 1	A2	b	D	E	E1	е	h	L	L1	L2	θ	θ1
Dimension (mm)	MIN	1.35*	0.10	1.25	0.31	4.80*	5.80*	3.80*		0.25	0.40			0 °	5°
	NOM	-	-	-	-	4.90	6.00	3.90	1.27 BSC	-	-	1.04 REF	0.25 BSC	-	-
()	MAX	1.75	0.25	1.65*	0.51	5.00*	6.20*	4.00*		0.50	1.27			8 º	15°

JEDEC Registration MS-012, Variation AA, Issue E, Sept. 2005.

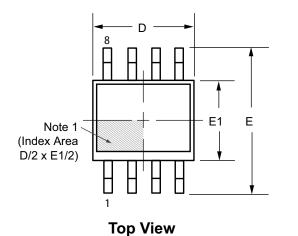
* This dimension is not specified in the JEDEC drawing.

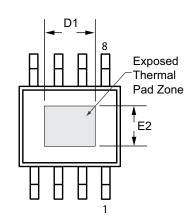
Drawings are not to scale.

Supertex Doc. #: DSPD-8SOLGTG, Version 1041309.

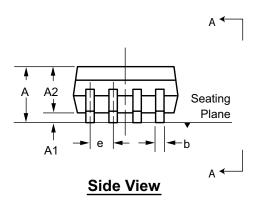
8-Lead SOIC (Narrow Body w/Heat Slug) Package Outline (SG)

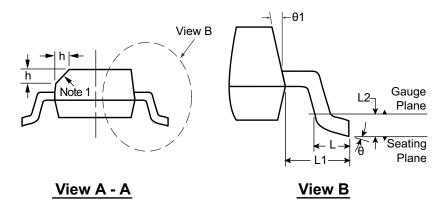
4.90x3.90mm body, 1.70mm height (max), 1.27mm pitch





Bottom View





Note:

1. If optional chamfer feature is not present, a Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbo	ol	Α	A1	A2	b	D	D1	Е	E1	E2	е	h	L	L1	L2	θ	θ1
	MIN	1.25*	0.00	1.25	0.31	4.80*	3.30 [†]	5.80*	3.80*	2.29 [†]		0.25	0.40			0 o	5 °
Dimension (mm)	NOM	-	-	-	-	4.90	-	6.00	3.90	-	1.27 BSC	-	-	1.04 REF	0.25 BSC	-	-
(11111)	MAX	1.70	0.15	1.55*	0.51	5.00*	3.81 [†]	6.20*	4.00*	2.79 [†]		0.50	1.27	'_'	200	8 º	15°

JEDEC Registration MS-012, Variation BA, Issue E, Sept. 2005.

Drawings not to scale.

Supertex Doc. #: DSPD-8SOSG, Version D041009.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to http://www.supertex.com/packaging.html.)

Supertex inc. does not recommend the use of its products in life support applications, and will not knowingly sell them for use in such applications unless it receives an adequate "product liability indemnification insurance agreement." **Supertex inc.** does not assume responsibility for use of devices described, and limits its liability to the replacement of the devices determined defective due to workmanship. No responsibility is assumed for possible omissions and inaccuracies. Circuitry and specifications are subject to change without notice. For the latest product specifications refer to the **Supertex inc.** (website: http://www.supertex.com)

©2013 **Supertex inc.** All rights reserved. Unauthorized use or reproduction is prohibited.



^{*} This dimension is not specified in the JEDEC drawing.

[†] This dimension differs from the JEDEC drawing.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Display Drivers & Controllers category:

Click to view products by Microchip manufacturer:

Other Similar products are found below:

ICB2FL01G HV5812PJ-G-M904 TW8813-LB2-GR TW8811-PC2-GR MAX1839EEP+ TW9907-TA1-GR LX27901IDW SSD2828QN4
ICB2FL01GXUMA2 DLP2000FQC PAD1000YFFR S1D13746F01A600 FIN324CMLX AD8387JSVZ DLPC6421ZPC HV852K7-G
HV859K7-G HV857K7-G DIO2133CT14 S1D13506F00A200 S1D13L03F00A100-40 TW2836-BA1-GR SSD2829QL9 MAX749CSA+T
MAX4820EUP+T ICL7135CAI+ ICL7135CMH+D ICL7137CMH+D MAX25221BATJ/V+ S1D13748B00B100 S1D13A05B00B200
MAX3738ETG+T MAX8722CEEG+ MAX749CPA+ MAX8785AETI+ ICL7135CQI+ HV518PJ-G-M903 HV5812P-G HV5812PJ-G
HV7224PG-G HV853K7-G HV860K7-G HV6810WG-G HV823LG-G HV857MG-G HV833MG-G HV857LMG-G HV859MG-G
FMS6363ACSX FMS6364AMTC14X